- K M Y	Last update: 2015.12.26 No.RNC-K-HTS-0001 (Uncontrolled cop
	Specification
	(Reference)
Title:	FIXED THIN FILM CHIP RESISTORS; RECTANGULAR TYPE
Style:	RNC06, 20, 32
	RoHS COMPLIANCE ITEM Halogen and Antimony Free
are If ye	duct specification contained in this specification subject to change at any time without notice ou have any questions or a Purchasing Specification for any quality reement is necessary, please contact our sales staff.
	资 法屋電機株式會社 KAMAYA ELECTRIC CO., LTD.

Issue Dept.: Research & Development Department Hokkaido Research Center

Drawing No: RNC–K–HTS–0001 /9
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### 1. Scope

- 1.1 This specification covers the detail requirements for fixed thin film chip resistors; rectangular type & precision, style of RNC06, 20, 32.
- 1.2 Applicable documents

JIS C 5201–1: 1998, JIS C 5201–8: 1998, JIS C 5201–8–1: 1998 IEC60115–1: 1999, IEC60115–8: 1989 Amendment 1: 1992, IEC60115–8–1: 1989 EIAJ RC–2133B–2002

# 2. Classification

Type designation shall be the following form.

pe designation			g ionn.			
(Example)	RNC	32	Е	1002	В	В
	1	2	3	4	5	6
	Styl	е				
1 Fixed thin film chip resistors; rectangular type Style						
2 Size Style					Otyle	
	3 Temperature coefficient of resistance $E \pm 25 \times 10^{6}$ / °C				±25×10 <sup>€</sup> / °C	
					С	±50×10 <sup>6</sup> / °C
A Pated resistance Example: 1002 \ 10k0						

- 4 Rated resistance Example;  $1002 \rightarrow 10k\Omega$
- 5 Tolerance on rated resistance
- 6 Packaging form

# 3. Rating

3.1 The ratings shall be in accordance with Table-1.

			Table-1			
Style	Rated dissipation (W)	Temperature coefficient of resistance (10 <sup>-6</sup> /°C)	Rated resistance range(Ω)	Preferred number series for resistors	Tolerance on rated resistance	
	0.03	E: ±25	100~10k		B(±0.1%)	
RNC06 0.05	E: ±25	27~4.99k		D(±0.5%)		
	0.05	C: ±50	5.1k~10k		D(±0.5 %)	
RNC20	BNC20 0.1	RNC20 0.1		100~130k	E24,96	B(±0.1%)
111020 0.1	E: +25	10~130k		C(±0.25%), D(±0.5%)		
RNC32	0.125	L. ±20	100~180k		B(±0.1%)	
	0.125		10~180k		C(±0.25%), D(±0.5%)	

T.I.I. 4

Style	Limiting element	Isolation Voltage	Category temperature
Style	voltage (V)	(V)	range(°C)
RNC06	15	50	
RNC20	100	100	-55~+155
RNC32	200	100	

3.2 Climatic category 55/125/56	Lower category tempera	ture	55 °C
	Upper category tempera		+155 °C
	Duration of the damp he	at, steady state test	56days
3.3 Stability class			
1%	Limits for change of resis	stance:	
	<ul> <li>for long - term tests</li> <li>for short - term tests</li> </ul>	±(1.0%+0.05Ω) ±(0.25%+0.05Ω)	

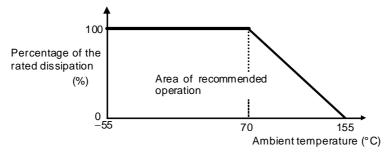
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### 3.4 Derating

The derated values of dissipation at temperature in excess of 70°C shall be as indicated by the following curve.





### 3.5 Rated voltage

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.



E: Rated voltage (V) P: Rated dissipation (W) R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

### 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	RNC06, 20, 32
PA	Press pocket taping (paper taping) 8mm width, 2mm pitches		15,000 pcs.	RNC06
TP	Paper taping 8mm width, 4mm pitches		5,000 pcs.	RNC20, 32

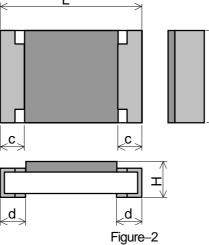
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### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure–2 and Table–3.



Table\_3

≥

Table-3					
Style	L	W	Н	С	d
RNC06	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05
RNC20	2.0 <del>±</del> 0.15	1.25 <sup>+0.10</sup> _0.05	0.6±0.1	0.4±0.2	0.3 <sup>+0.2</sup> 0.1
RNC32	3.1±0.1	1.55 <sup>+0.10</sup> _0.05	0.6±0.1	0.45 <u>+</u> 0.20	0.3 <sup>+0.2</sup> 0.1

### 5.2 Net weight (Reference)

Style	Net weight(mg)
RNC06	0.16
RNC20	5
RNC32	9

### 6. Marking

The Rated resistance shall be marked in 3 digits (E24) or 4 digits (E96) and marked on over coat side. The Rated resistance of RNC06 should not be marked.

(Example)

$$\label{eq:alpha} \begin{split} ``123" &\rightarrow 12 \times 10^3 \ [\Omega] \rightarrow 12 \ [\text{k}\Omega] \\ ``3R3" &\rightarrow 3.3 \ [\Omega] \\ ``5623" &\rightarrow 562 \times 10^3 \ [\Omega] \rightarrow 562 \ [\text{k}\Omega] \end{split}$$

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# 7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 1998.

7.2 The performance shall be satisfied in Table-4.

		Table-4(1)		
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements	
1	Visual examination	Sub–clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as checked by visual examination.	
2 Dimension		Sub-clause 4.4.2	As specified in Table-3 of this specification.	
	Resistance	Sub-clause 4.5	As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance.	
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4(See Figure-5) Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: $60 \text{ s} \pm 5 \text{ s}$ Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	No breakdown or flash over $R \ge 1 \ G \ \Omega$	
4	Solderability	Sub-clause 4.17 Without ageing Flux: The resistors shall be immersed in a non-activated soldering flux for 2s. Bath temperature: $235 \degree C \pm 5 \degree C$ Immersion time: $2 \ s \pm 0.5 \ s$	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.	
5	Mounting Overload (in the mounted state) Solvent resistance of th marking	Solvent: 2–propanol	No visible damage ΔR ≤ ± (0.25%+0.05Ω) Legible marking	
		Solvent temperature: 23 °C ± 5 °C Method 1 Rubbing material: cotton wool Without recovery		

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	Table-4(2)				
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements		
6	Mounting	Sub-clause 4.31			
		Substrate material: Epoxide woven glass			
		Test substrate: Figure-4			
	Bound strength of the end face	Sub-clause 4.33			
	plating	Bent value: 3 mm			
		Resistance	$\Delta R \le \pm (0.25\% + 0.05\Omega)$		
	Final measurements	Sub–clause 4.33.6			
		Visual examination	No visible damage		
7	Resistance to soldering heat	Sub-clause 4.18			
	_	Solder temperature: $260 \degree C \pm 5 \degree C$			
		Immersion time: $10 \text{ s} \pm 0.5 \text{ s}$			
		Visual examination	As in 4.18.3.4		
			No sign of damage such as cracks.		
		Resistance	$\Delta R \le \pm (0.25\% + 0.05\Omega)$		
	Component solvent resistance	Sub–clause 4.29			
		Solvent: 2-propanol			
		Solvent temperature: 23 °C ± 5 °C			
		Method 2			
		Recovery: 48 h			
		Visual examination	No visible damage		
		Resistance	$\Delta R \le \pm (0.25\% + 0.05\Omega)$		
8	Mounting	Sub–clause 4.31			
		Substrate material: Epoxide woven glass			
		Test substrate: Figure–3			
	Adhesion	Sub–clause 4.32			
		Force: 5 N (RNC06: 3N)			
		Duration: $10 \text{ s} \pm 1 \text{ s}$	Nie vielble de see as		
	Rapid change temperature	Visual examination	No visible damage		
		Sub–clause 4.19			
		Lower category temperature: –55 °C			
		Upper category temperature: +155 °C			
		Duration of exposure at each temperature: 30			
		min.			
		Number of cycles: 5 cycles.	No visible damage		
		Visual examination	$\Delta R \le \pm (0.25\% + 0.05\Omega)$		
l]		Resistance			

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	Table-4(3)				
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements		
9	Climatic sequence	Sub-clause 4.23			
	–Dry heat	Sub-clause 4.23.2			
		Test temperature: + 155 °C			
		Duration: 16 h			
	–Damp heat, cycle	Sub-clause 4.23.3			
	(12+12hour cycle)	Test method: 2			
	First cycle	Test temperature: 55 °C			
		[Severity(2)]			
	Cold	Sub-clause 4.23.4			
		Test temperature –55 °C			
		Duration: 2h			
	-Damp heat, cycle	Sub-clause 4.23.6			
	(12+12hour cycle)	Test method: 2			
	Remaining cycle	Test temperature: 55 °C			
		[Severity (2)]			
		Number of cycles: 5 cycles			
	–D.C. load	Sub-clause 4.23.7			
		The applied voltage shall be the rated voltage			
		or the limiting element voltage whichever is			
		the smaller.			
		Duration: 1 min.	No visible damage		
		Visual examination	$\Delta R \leq \pm (1\% + 0.05\Omega)$		
10	Mounting	Resistance Sub–clause 4.31	,		
10	Woulling				
		Substrate material: Epoxide woven glass Test substrate: Figure–3			
	Endurance at 70 °C	Sub-clause 4.25.1			
		Ambient temperature: 70 °C $\pm$ 2 °C			
		Duration: 1000 h			
		The voltage shall be applied in cycles of 1.5 h			
		on and 0.5 h.			
		The applied voltage shall be the rated voltage			
		or the limiting element voltage whichever is			
		the smaller.			
		Examination at 48 h, 500 h and			
		1000 h:			
		Visual examination	No visible damage		
		Resistance	ΔR ≤ ± (1%+0.05Ω)		

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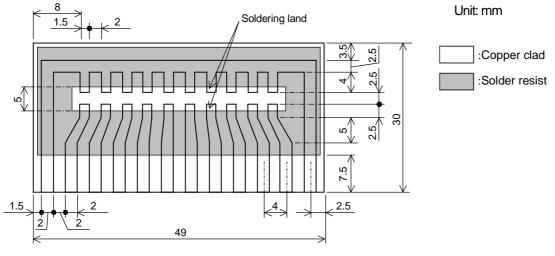
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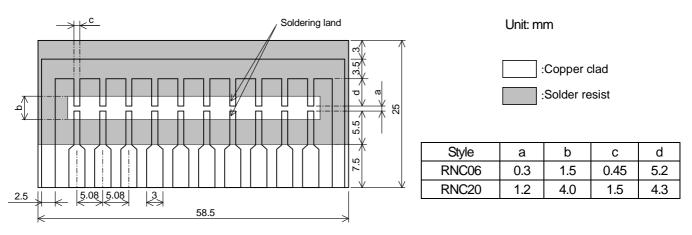
	Table-4(4)					
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements			
11	Mounting Variation of resistance with	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub–clause 4.8	As in Table-1			
	temperature	+20 °C / +125°C				
12	Mounting Damp heat, steady state	<ul> <li>Sub-clause 4.31</li> <li>Substrate material: Epoxide woven glass</li> <li>Test substrate: Figure-3</li> <li>Sub-clause 4.24</li> <li>Ambient temperature: 40 °C ± 2 °C</li> <li>Relative humidity : 93 <sup>+2</sup>/<sub>-3</sub> %</li> <li>a) 1st group: without voltage applied.</li> <li>b) 2nd group: The d.c.voltage shall be applied continuously.</li> <li>The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)]</li> <li>Visual examination</li> </ul>	No visible damage Legible marking $\Delta R \leq \pm (1\%+0.05\Omega)$			
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table–3			
	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3				
	Endurance at upper category temperature	Sub-clause 4.25.3 Ambient temperature: $155 \text{ °C} \pm 2 \text{ °C}$ Duration: $1000 \text{ h}$ Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage $\Delta R \leq \pm (1\%+0.05\Omega)$			

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### 8. Test substrate



### RNC32 TEST SUBSTRATE



### RNC06, 20 TEST SUBSTRATE Figure–3

Remark 1). Material: Epoxide woven glass Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

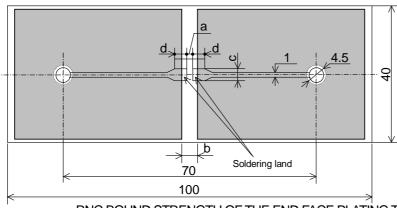
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Unit: mm

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	:Solder resist			
Style	а	b	С	d
RNC06	0.3	1.1	0.45	2.15
RNC20	1.2	4.0	1.65	3.0
RNC32	2.5	5.0	2.0	2.5

:Copper clad

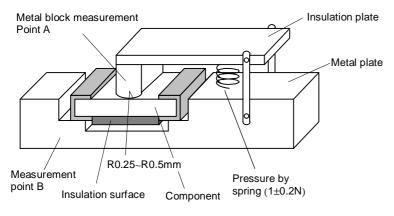
RNC BOUND STRENGTH OF THE END FACE PLATING TEST TEST SUBSTRATE

Figure-4

Remark 1). Material: Epoxide woven glass Thickness: 1.6mm Thickness of copper clad: 0.035mm

· RNC20, 32

· RNC06



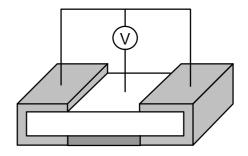


Figure-5

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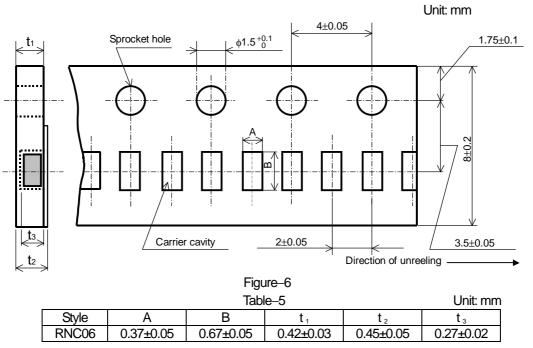
### 9. Taping

9.1 Applicable documents JIS C 0806–3: 1999, EIAJ ET–7103: 2004, EIAJ ET–7200B: 2003

9.2 Taping dimensions

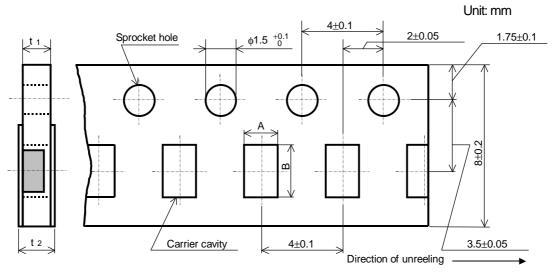
9.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-5.



### 9.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-6.



		Figure–7		
		Table-6		Unit: mm
Style	А	В	<b>t</b> 1	<b>t</b> 2
RNC20	1.65 ± 0.15	2.5 ± 0.2	0.0.01	1.0max.
RNC32	2.00 ± 0.15	$3.6 \pm 0.2$	0.8 ± 0.1	T.OMAX.

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RNC06: Figure–8, RNC20, 32: Figure–9.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

The maximum number of missing components shall be one or 0.1%, whichever is greater.

8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

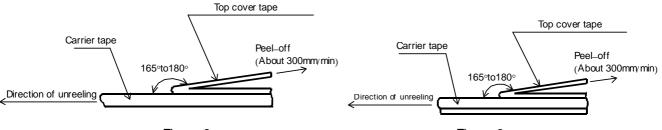
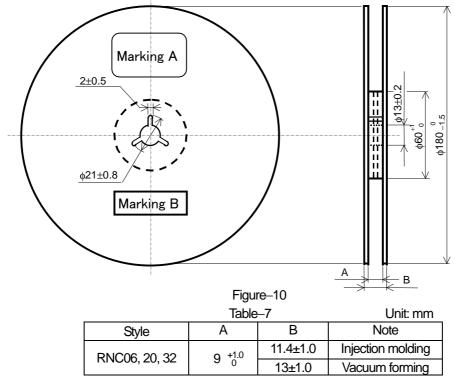




Figure-9

9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–10 and Table–7. Plastic reel (Based on EIAJ ET–7200B) Unit: mm



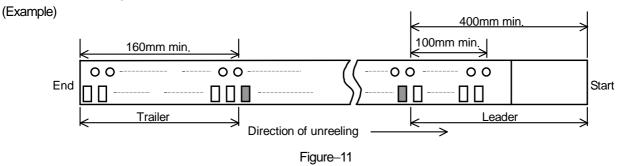
Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

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9.4 Leader and trailer tape.



# 10. Marking on package

The label of a minimum package shall be legibly marked with follows.

- 10.1 Marking A
  - (1) Classification
    - (Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)
  - (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

10.2 Marking B (KAMAYA Control label)

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# Kamaya:

RNC20E1372BTPRNC32E823BTPRNC32E1001BTPRNC20E682DTPRNC20E1001BTPRNC32E2002BTPRNC20E241BTPRNC20E1431BTPRNC20E2492BTPRNC20E2002BTPRNC32E272BTPRNC20E1501BTPRNC20E1000BTPRNC20E21R5DTPRNC20E7502BTPRNC32E513BTPRNC32E2550BTPRNC20E1003BTPRNC20E1241BTPRNC20E2152BTPRNC32E7502BTPRNC20E2002DTPRNC32E3010BTPRNC20E21R0DTPRNC20E1002BTPRNC20E5111BTPRNC06E512BPARNC20E1331BTPRNC32E124BTPRNC32E3012BTPRNC20E4020BTPRNC20E152DTPRNC32E6192BTPRNC32E2701BTPRNC20E2400BTPRNC32E8202BTPRNC20E1501DTPRNC32E1203BTPRNC06E5101BPARNC20E6801DTPRNC32E5102BTPRNC20C1132FT